

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	HO CHEUNG LAU	08/28/2017
RECEIVING PARTY DATA		
Name:	DEFOND COMPONENTS LIMITED	
Street Address:	5/F, CHAI WAN INDUSTRIAL CENTRE	
Internal Address:	20 LEE CHUNG STREET	
City:	CHAI WAN	
State/Country:	HONG KONG	
PROPERTY NUMBERS Total: 1		
Property Type	Number	
Application Number:	15712522	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
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NAME OF SUBMITTER:	JOSEPH G. CHU	
SIGNATURE:	/joseph g. chu/	
DATE SIGNED:	09/22/2017	
Total Attachments: 2		
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ASSIGNMENT

WHEREAS, I, Ho Cheung LAU, whose post office address appears below, hereinafter called "ASSIGNOR", have made certain new and useful inventions or discoveries relating to:

**LOCKABLE TRIGGER MECHANISM FOR USE
IN AN ELECTRICAL DEVICE**

(hereinafter referred to as the "INVENTION") for which an application for United States Patent

☒	filed on even date herewith
☐	filed on: _____ as Serial No.: _____

WHEREAS, DEFOND COMPONENTS LIMITED, a company, whose address is 5/F, Chai Wan Industrial Centre, 20 Lee Chung Street, Chai Wan, Hong Kong, hereinafter called "ASSIGNEE", is desirous of acquiring ASSIGNOR'S entire right, title and interest therein:

NOW THEREFORE, BE IT KNOWN that for valuable considerations to them moving, the receipt of which is hereby acknowledged, ASSIGNOR has sold, assigned, and transferred, and do hereby sell, assign and transfer unto said ASSIGNEE his/her entire right, title and interest in and to all said inventions and discoveries regarding the INVENTION and disclosed in said application whose identification above by title, and by serial number and filing date when available, is hereby authorized, and in and to said application, all substitutions, divisions, continuations and continuations-in-part thereof, and to any and all priority rights and to all Patents, United States and foreign, that may be granted for the INVENTION, and in and to all extensions, renewals, reissues and reexaminations thereof, the same to be held and enjoyed by said ASSIGNEE, its successors and assigns, as fully and entirely as the same would have been held and enjoyed by ASSIGNOR if this Assignment and sale had not been made;

And ASSIGNOR hereby authorizes and requests the Commissioner of Patents of the United States to issue said Patent in accordance with this Assignment;

And for the consideration aforesaid, ASSIGNOR covenants and agrees with said ASSIGNEE that he/she has a full and unencumbered title to the inventions and discoveries above described and hereby assigned, which title he/she warrants unto said ASSIGNEE, its successors and assigns;

And for the consideration aforesaid, ASSIGNOR further covenants and agrees that he/she will, whenever requested, but without cost to him/her,

promptly communicate to said ASSIGNEE or its representatives any facts known to him/her relating to said invention and discoveries, testify in any interference or legal proceedings involving said inventions and discoveries, and execute any additional papers that may be necessary to enable said ASSIGNEE or its representatives, successors, nominees, or assigns to secure full and complete protection for the said inventions and discoveries or that may be necessary to vest in said ASSIGNEE the complete title to the said inventions and discoveries and patents hereby conveyed and to enable it to record said title.

IN TESTIMONY WHEREOF, ASSIGNOR has hereunto set his/her signature as follows:

ASSIGNOR NAME: Ho Cheung LAU
By **DEFOND COMPONENTS LIMITED**
Assignee and person to whom the inventor is
under obligation to assign
ADDRESS: 5/F, Chai Wan Industrial Centre
20 Lee Chung Street
Chai Wan, Hong Kong

X  Aug 28, 2017
Signature Date
Name: RICHARD OR TAK CHUEN
Title: CEO